# **Switching Diode**

### **Features**

• These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	$V_R$	75	Vdc
Peak Forward Current	Ιϝ	200	mAdc
Peak Forward Surge Current	I <sub>FM(surge)</sub>	500	mAdc

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1)  T <sub>A</sub> = 25°C  Derate above 25°C	P <sub>D</sub>	200 1.57	mW mW/°C
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	635	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C

1. FR-4 Minimum Pad.



### ON Semiconductor®

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SOD-323 CASE 477 STYLE 1

### **MARKING DIAGRAM**



A6 = Specific Device Code M = Date Code

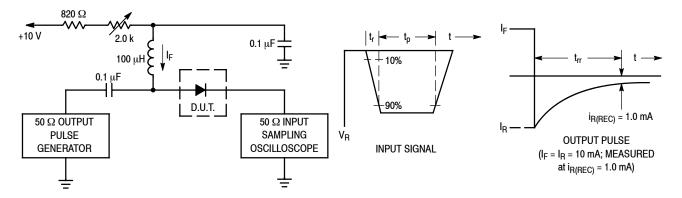
### **ORDERING INFORMATION**

Device	Package	Shipping†
BAS16HT1	SOD-323	3000/Tape & Reel
BAS16HT1G	SOD-323 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS			•	•
Reverse Voltage Leakage Current $(V_R = 75 \text{ Vdc})$ $(V_R = 75 \text{ Vdc}, T_J = 150^{\circ}\text{C})$ $(V_R = 25 \text{ Vdc}, T_J = 150^{\circ}\text{C})$	I <sub>R</sub>	- - -	1.0 50 30	μAdc
Reverse Breakdown Voltage (I <sub>BR</sub> = 100 μAdc)	V <sub>(BR)</sub>	75	-	Vdc
Forward Voltage $ \begin{aligned} &(I_F=1.0 \text{ mAdc})\\ &(I_F=10 \text{ mAdc})\\ &(I_F=50 \text{ mAdc})\\ &(I_F=150 \text{ mAdc}) \end{aligned} $	V <sub>F</sub>	- - - -	715 855 1000 1250	mV
Diode Capacitance (V <sub>R</sub> = 0, f = 1.0 MHz)	C <sub>D</sub>	-	2.0	pF
Forward Recovery Voltage (I <sub>F</sub> = 10 mAdc, t <sub>r</sub> = 20 ns)	V <sub>FR</sub>	-	1.75	Vdc
Reverse Recovery Time (I <sub>F</sub> = I <sub>R</sub> = 10 mAdc, R <sub>L</sub> = 50 $\Omega$ )	t <sub>rr</sub>	-	6.0	ns
Stored Charge $ \text{(I}_{\text{F}} = 10 \text{ mAdc to V}_{\text{R}} = 5.0 \text{ Vdc}, \\ \text{R}_{\text{L}} = 500 \ \Omega \text{)} $	Q <sub>S</sub>	-	45	pC



Notes: 1. A 2.0  $k\Omega$  variable resistor adjusted for a Forward Current (I<sub>F</sub>) of 10 mA.

- 2. Input pulse is adjusted so  $I_{R(peak)}$  is equal to 10 mA.
- 3. t<sub>p</sub> » t<sub>rr</sub>

Figure 1. Recovery Time Equivalent Test Circuit

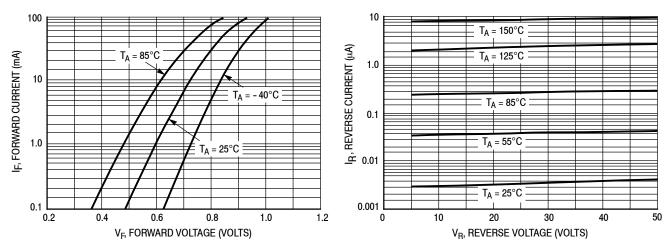


Figure 2. Forward Voltage

Figure 3. Leakage Current

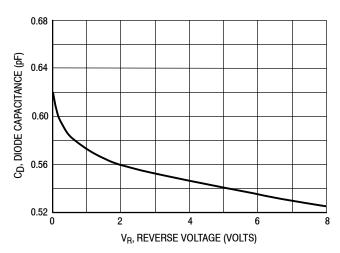
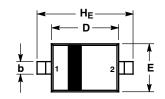
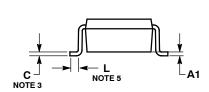


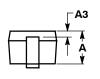
Figure 4. Capacitance

### PACKAGE DIMENSIONS

SOD-323 CASE 477-02 **ISSUE H** 







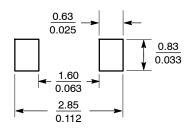
#### NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
- CONTROLLING DIMENSION: MILLIMETERS.
  LEAD THICKNESS SPECIFIED PER L/F DRAWING
- WITH SOLDER PLATING.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- DIMENSION L IS MEASURED FROM END OF RADIUS.

	MI	MILLIMETERS			INCHES		
DII	MIN N	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.90	1.00	0.031	0.035	0.040	
A	0.00	0.05	0.10	0.000	0.002	0.004	
A	3	0.15 REF			0.006 REF		
b	0.25	0.32	0.4	0.010	0.012	0.016	
С	0.089	0.12	0.177	0.003	0.005	0.007	
D	1.60	1.70	1.80	0.062	0.066	0.070	
E	1.15	1.25	1.35	0.045	0.049	0.053	
L	0.08			0.003			
He	2.30	2.50	2.70	0.090	0.098	0.105	

STYLE 1:
PIN 1. CATHODE (POLARITY BAND)

#### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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